

VNP28N04

"OMNIFET": FULLY AUTOPROTECTED POWER MOSFET

TYPE	V _{clamp}	R _{DS(on)}	l _{lim}
VNP28N04	42 V	0.035 Ω	28 A

- LINEAR CURRENT LIMITATION
- THERMAL SHUT DOWN
- SHORT CIRCUIT PROTECTION
- INTEGRATED CLAMP
- LOW CURRENT DRAWN FROM INPUT PIN
- DIAGNOSTIC FEEDBACK THROUGH INPUT PIN
- ESD PROTECTION
- DIRECT ACCESS TO THE GATE OF THE POWER MOSFET (ANALOG DRIVING)
- COMPATIBLE WITH STANDARD POWER MOSFET
- STANDARD TO-220 PACKAGE

DESCRIPTION

The VNP28N04 is a monolithic device made using STMicroelectronics VIPower Technology, intended for replacement of standard power MOSFETS in DC to 50 KHz applications. Built-in thermal shut-down, linear current limi-



tation and overvoltage clamp protect the chip in harsh enviroments.

Fault feedback can be detected by monitoring the voltage at the input pin.

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Value	Unit
Vds	Drain-source Voltage (V _{in} = 0)	Internally Clamped	V
Vin	Input Voltage	18	V
ID	Drain Current	Internally Limited	А
I _R	Reverse DC Output Current	-28	А
V _{esd}	Electrostatic Discharge (C= 100 pF, R=1.5 KΩ)	2000	V
P _{tot}	Total Dissipation at $T_c = 25 \ ^{\circ}C$	83	W
Tj	Operating Junction Temperature	Internally Limited	°C
Tc	Case Operating Temperature	Internally Limited	°C
T _{stg}	Storage Temperature	-55 to 150	°C

THERMAL DATA

R _{thj-case}	Thermal Resistance Junction-cas	e Max	1.5	°C/W
R _{thj-amb}	Thermal Resistance Junction-am	bient Max	62.5	°C/W

ELECTRICAL CHARACTERISTICS ($T_{case} = 25 \ ^{\circ}C$ unless otherwise specified) OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Vclamp	Drain-source Clamp Voltage	$I_D = 200 \text{ mA}$ $V_{in} = 0$	36	42	48	V
V _{CLTH}	Drain-source Clamp Threshold Voltage	$I_D = 2 \text{ mA}$ $V_{in} = 0$	35			V
VINCL	Input-Source Reverse Clamp Voltage	l _{in} = -1 mA	-1		-0.3	V
I _{DSS}	Zero Input Voltage Drain Current (V _{in} = 0)				50 200	μΑ μΑ
liss	Supply Current from Input Pin	$V_{DS} = 0 V V_{in} = 10 V$		250	500	μA

ON (*)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{IN(th)}	Input Threshold Voltage	$V_{DS} = V_{in}$ $I_D + I_in = 1 \text{ mA}$	0.8		3	V
R _{DS(on)}	Static Drain-source On Resistance	$V_{in} = 10 V$ $I_D = 14 A$ $V_{in} = 5 V$ $I_D = 14 A$			0.035 0.05	Ω Ω

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g _{fs} (*)	Forward Transconductance	V _{DS} = 13 V I _D = 14 A	14	18		S
Coss	Output Capacitance	$V_{DS} = 13 V$ f = 1 MHz $V_{in} = 0$		700	900	pF

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ELECTRICAL CHARACTERISTICS (continued)

SWITCHING (**)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on Delay Time	$V_{DD} = 15 V$ $I_d = 14 A$		100	200	ns
tr	Rise Time	$V_{gen} = 10 V$ $R_{gen} = 10 \Omega$		330	600	ns
t _{d(off)}	Turn-off Delay Time	(see figure 3)		400	700	ns
t _f	Fall Time			155	300	ns
t _{d(on)}	Turn-on Delay Time	V _{DD} = 15 V I _d = 14 A		450	700	ns
tr	Rise Time	$V_{gen} = 10 V$ $R_{gen} = 1000 \Omega$		1.7	3	μs
t _{d(off)}	Turn-off Delay Time	(see figure 3)		7.5	10	μs
t _f	Fall Time			3.4	5	μs
(di/dt) _{on}	Turn-on Current Slope	V _{DD} = 15 V I _D = 14 A		35		A/μs
		$V_{in} = 10 V$ $R_{gen} = 10 \Omega$				
Qi	Total Input Charge	$V_{DD} = 12 \text{ V}$ $I_D = 10 \text{ A}$ $V_{in} = 10 \text{ V}$		60		nC

SOURCE DRAIN DIODE

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{SD} (*)	Forward On Voltage	$I_{SD} = 14 \text{ A} V_{in} = 0$			1.6	V
t _{rr} (**)	Reverse Recovery Time	$I_{SD} = 14 \text{ A}$ di/dt = 100 A/µs V _{DD} = 30 V $T_i = 25 ^{\circ}\text{C}$		180		ns
Q _{rr} (**)	Reverse Recovery Charge	(see test circuit, figure 5)		0.45		μC
I _{RRM} (**)	Reverse Recovery Current			7		A

PROTECTION

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
l _{lim}	Drain Current Limit		20 20	28 28	40 40	A A
t _{dlim} (**)	Step Response Current Limit	V _{in} = 10 V V _{in} = 5 V		25 70	40 120	μs μs
T _{jsh} (**)	Overtemperature Shutdown		150			°C
T _{jrs} (**)	Overtemperature Reset		135			°C
I _{gf} (**)	Fault Sink Current			50 20		mA mA
E _{as} (**)	Single Pulse Avalanche Energy	starting $T_j = 25 \text{ °C}$ $V_{DD} = 20 \text{ V}$ $V_{in} = 10 \text{ V}$ $R_{gen} = 1 \text{ K}\Omega$ $L = 10 \text{ mH}$	2.5			J

(*) Pulsed: Pulse duration = $300 \ \mu$ s, duty cycle 1.5 % (**) Parameters guaranteed by design/characterization

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PROTECTION FEATURES

During normal operation, the Input pin is electrically connected to the gate of the internal power MOSFET. The device then behaves like a standard power MOSFET and can be used as a switch from DC to 50 KHz. The only difference from the user's standpoint is that a small DC current ($I_{\rm ISS}$) flows into the Input pin in order to supply the internal circuitry.

The device integrates:

- OVERVOLTAGE CLAMP PROTECTION: internally set at 42V, along with the rugged avalanche characteristics of the Power MOSFET stage give this device unrivalled ruggedness and energy handling capability. This feature is mainly important when driving inductive loads.
- LINEAR CURRENT LIMITER CIRCUIT: limits the drain current ld to llim whatever the Input pin voltage. When the current limiter is active, the device operates in the linear region, so power dissipation may exceed the capability of the heatsink. Both case and junction temperatures increase, and if this phase lasts long enough, junction temperature may reach the overtemperature threshold T_{jsh}.
- OVERTEMPERATURE AND SHORT CIRCUIT PROTECTION: these are based on sensing the chip temperature and are not dependent on the input voltage. The location of the sensing element on the chip in the power stage area ensures fast, accurate detection of the junction temperature. Overtemperature cutout occurs at minimum 150°C. The device is automatically restarted when the chip temperature falls below 135°C.
- STATUS FEEDBACK: In the case of an overtemperature fault condition, a Status Feedback is provided through the Input pin. The internal protection circuit disconnects the input from the gate and connects it instead to ground via an equivalent resistance of 100 Ω . The failure can be detected by monitoring the voltage at the Input pin, which will be close to ground potential.

Additional features of this device are ESD protection according to the Human Body model and the ability to be driven from a TTL Logic circuit (with a small increase in $R_{DS(on)}$).

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Thermal Impedance



Output Characteristics



Static Drain-Source On Resistance vs Input Voltage



Derating Curve



Transconductance



Static Drain-Source On Resistance





Static Drain-Source On Resistance

Capacitance Variations



Normalized On Resistance vs Temperature



Input Charge vs Input Voltage



Normalized Input Threshold Voltage vs Temperature



Normalized On Resistance vs Temperature



Turn-on Current Slope



Turn-off Drain-Source Voltage Slope



Switching Time Resistive Load



Turn-on Current Slope



Turn-off Drain-Source Voltage Slope







Switching Time Resistive Load



Step Response Current Limit



Current Limit vs Junction Temperature



Source Drain Diode Forward Characteristics



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Fig. 1: Unclamped Inductive Load Test Circuits



Fig. 3: Switching Times Test Circuits For Resistive Load



Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times



Fig. 2: Unclamped Inductive Waveforms



Fig. 4: Input Charge Test Circuit



Fig. 6: Waveforms



VNP28N04

TO-220 MECHANICAL DATA

DIM		mm.			
	MIN.	ТҮР	MAX.		
A	4.40		4.60		
b	0.61		0.88		
b1	1.15		1.70		
С	0.49		0.70		
D	15.25		15.75		
E	10		10.40		
e	2.40		2.70		
e1	4.95		5.15		
F	1.23		1.32		
H1	6.20		6.60		
J1	2.40		2.72		
L	13		14		
L1	3.50		3.93		
L20		16.40			
L30		28.90			
ØP	3.75		3.85		
Q	2.65		2.95		
Package Weight		1.9Gr. (Typ.)			



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